

Primax

Synonymous with function and performance, enter the Primax, the new era of high intensity illumination in LED. With its high flux output and high luminous intensity, Primax transcends today LED lightings technology and how we perceive it. The small package outline and high intensity make it an ideal choice for backlighting, signage, interior automotive lighting and decorative lighting.



Features:

- > Super high brightness surface mount LED
- > 120° viewing angle.
- > Compact package outline (LxW) of 3.7 x 3.5 mm.
- > Ultra low height profile - 0.8mm.
- > Low thermal resistance.
- > Compatible to IR reflow soldering.
- > Superior corrosion resistant.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q102.

Applications:

- > Automotive Interior Lighting: eg: Dome Lamp, Map Lighting, Trunk Lighting.
- > Industrial Illumination.
- > White Goods Lighting.

Optical Characteristics at T_j=25°C

Part Number	Color, λ _{dom} (nm)		Viewing Angle °	Luminous Flux @ 150mA (lm) ^{Appx. 1.2}					
	Chip #1	Chip #2		Min.	Typ.	Max.	Min.	Typ.	Max.
● MCFW-EZHG-Q3R+RS2-1+1	Warm White,	White	120	34.8	45.2	51.7	39.8	51.7	59.0

● Not for new design

Note:

1. High color rendering index (CRI), minimum CRI of 80.

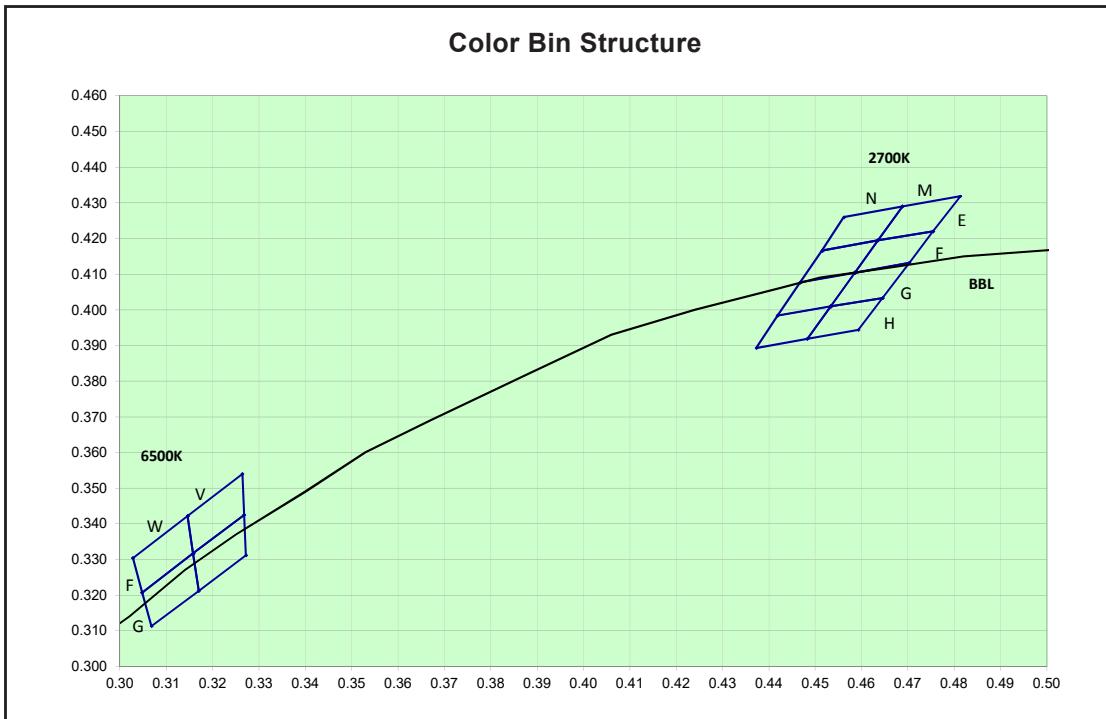
Electrical Characteristics at T_j=25°C

Part Number	V _f @ I _f = 150 mA ^{Appx. 3.1}		
	Min. (V)	Typ. (V)	Max. (V)
MCFW-EZHG	2.80	3.10	3.40

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	250	mA
Peak pulse current (T _s ≤ 55°C, t _p ≤ 100μs, Duty cycle=0.03)	500	mA
Reverse Voltage	Not designed for reverse bias	V
ESD threshold (HBM)	8	kV
LED junction temperature	150	°C
Operating temperature	-40 ... +125	°C
Storage temperature	-40 ... +125	°C
Thermal resistance - Real Thermal Resistance		
Junction / solder point, R _{th JS} real (Typ = 25K/W)	30	K/W
- Electrical Thermal Resistance		
Junction / solder point, R _{th JS} el (Typ = 18K/W)	21	K/W

MCFW-EZHG, Color Grouping Appx. 2.1



Bin		1	2	3	4
NE	Cx	0.4688	0.4635	0.4515	0.4562
	Cy	0.4290	0.4195	0.4166	0.4260
NF	Cx	0.4468	0.4585	0.4635	0.4515
	Cy	0.4077	0.4104	0.4195	0.4166
NG	Cx	0.4585	0.4534	0.4419	0.4468
	Cy	0.4104	0.4010	0.3984	0.4077
NH	Cx	0.4534	0.4419	0.4373	0.4483
	Cy	0.4010	0.3984	0.3893	0.3919
ME	Cx	0.4813	0.4754	0.4635	0.4688
	Cy	0.4319	0.4220	0.4195	0.4290
MF	Cx	0.4754	0.4635	0.4585	0.4703
	Cy	0.4220	0.4195	0.4104	0.4132
MG	Cx	0.4585	0.4533	0.4645	0.4703
	Cy	0.4104	0.4010	0.4033	0.4132
MH	Cx	0.4533	0.4645	0.4593	0.4483
	Cy	0.4010	0.4033	0.3944	0.3919
WF	Cx	0.3028	0.3146	0.3158	0.3048
	Cy	0.3304	0.3422	0.3317	0.3207
WG	Cx	0.3048	0.3158	0.3170	0.3068
	Cy	0.3207	0.3317	0.3212	0.3113
VF	Cx	0.3146	0.3264	0.3268	0.3158
	Cy	0.3422	0.3540	0.3425	0.3317
VG	Cx	0.3158	0.3268	0.3272	0.3170
	Cy	0.3317	0.3425	0.3312	0.3212

InGaN wavelength is very sensitive to drive current. Operating at lower current is not recommended and may yield unpredictable performance. Current pulsing should be used for dimming purposes.

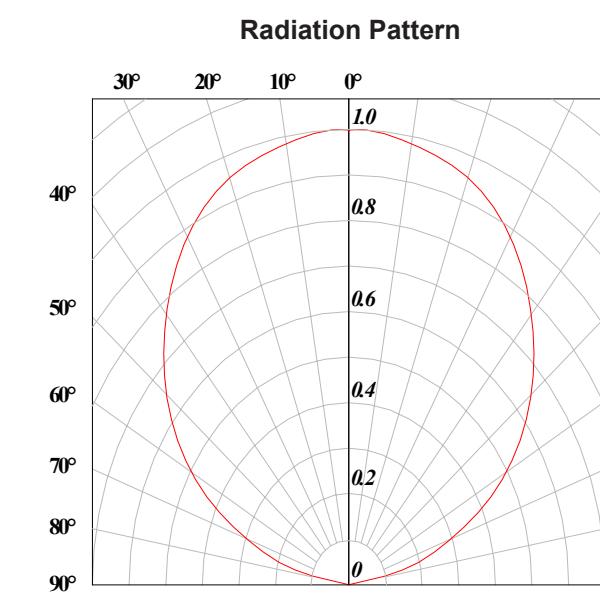
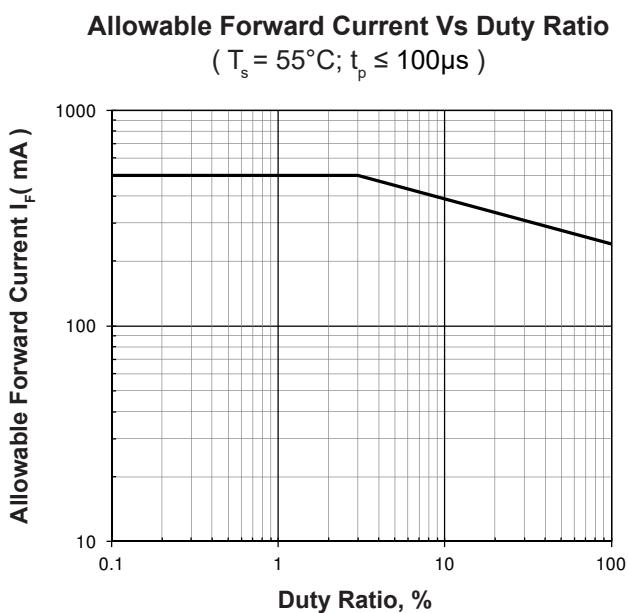
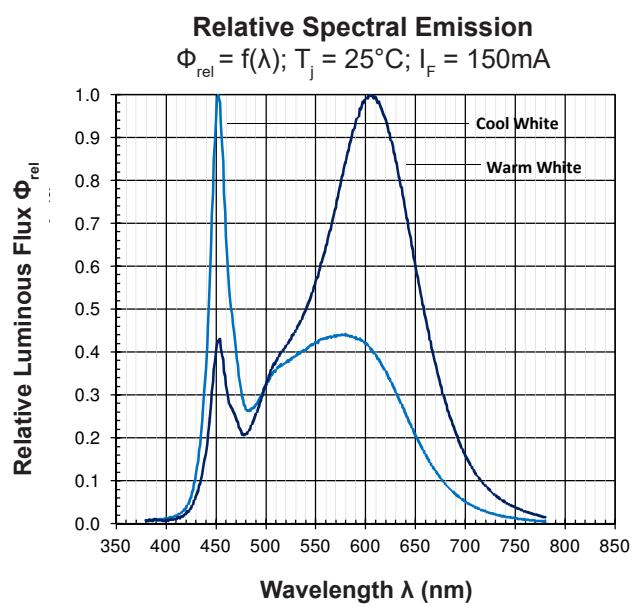
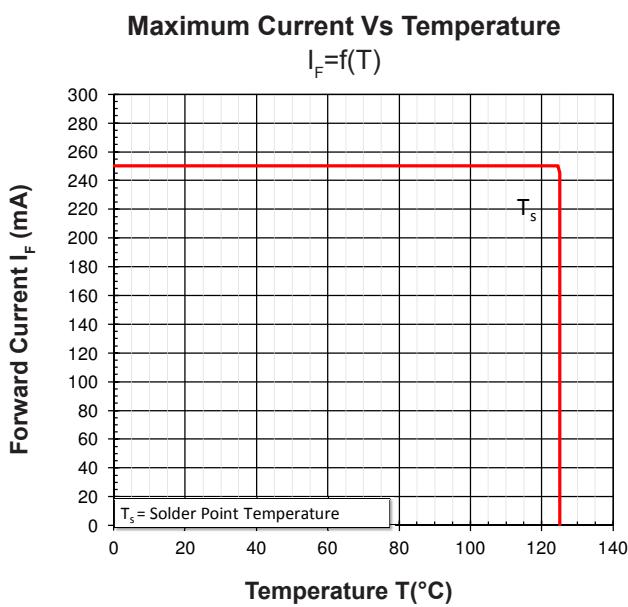
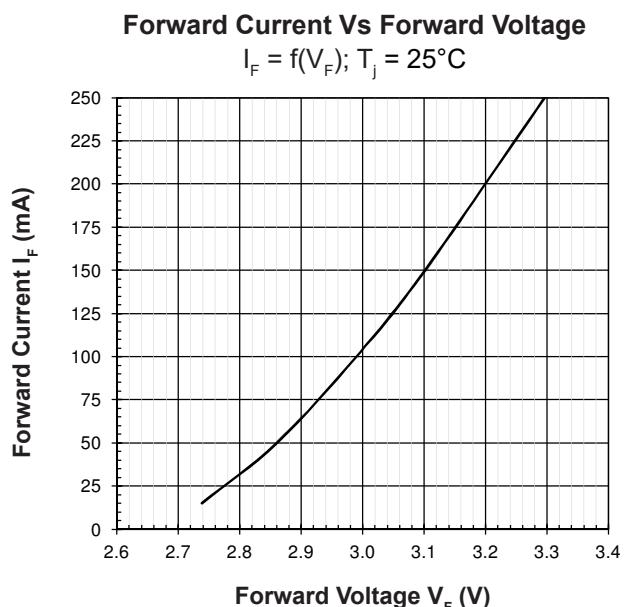
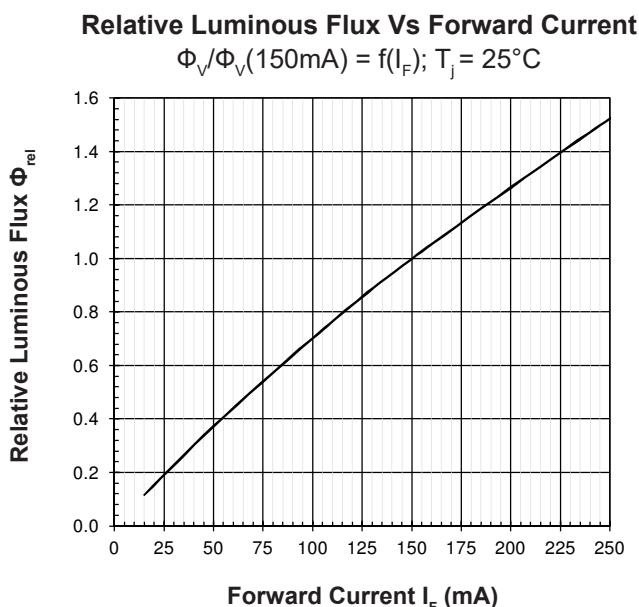
Luminous Flux at T_j=25°C

Brightness Group	Luminous Flux @ If=150mA (lm) <small>Appx. 1.2</small>
Q3	34.8 ... 39.8
R2	39.8 ... 45.2
R3	45.2 ... 51.7
S2	51.7 ... 59.0

Vf Binning (Optional)

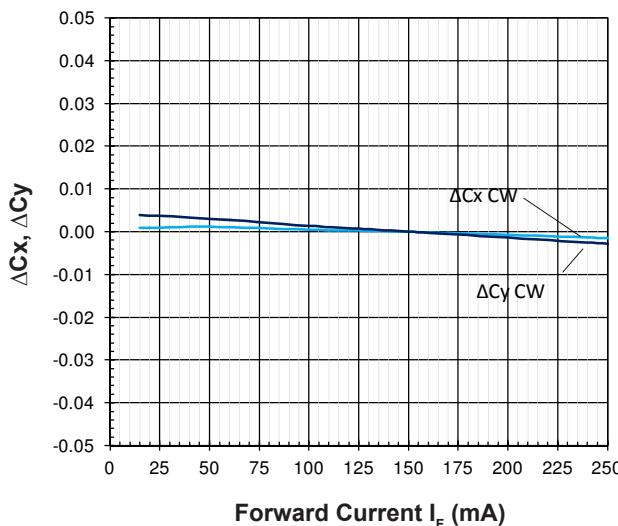
Vf Bin @ 150mA	Forward Voltage (V) <small>Appx. 3.1</small>
R7	2.80 ... 3.10
R8	3.10 ... 3.40

Please consult sales and marketing for special part number to incorporate Vf binning.



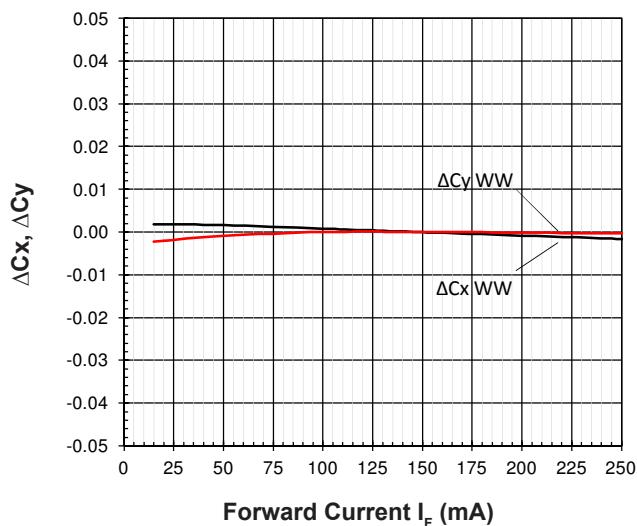
Chromaticity Coordinate Shift Vs Forward Current

$\Delta Cx, \Delta Cy = f(I_F); T_j = 25^\circ\text{C}$ (Cool White)



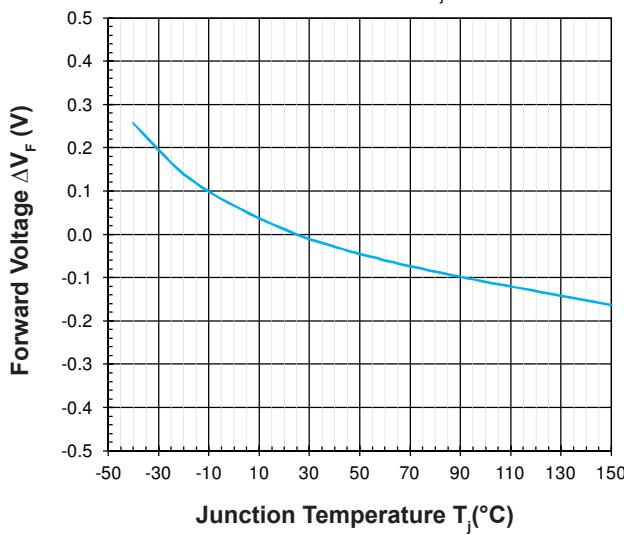
Chromaticity Coordinate Shift Vs Forward Current

$\Delta Cx, \Delta Cy = f(I_F); T_j = 25^\circ\text{C}$ (Warm White)



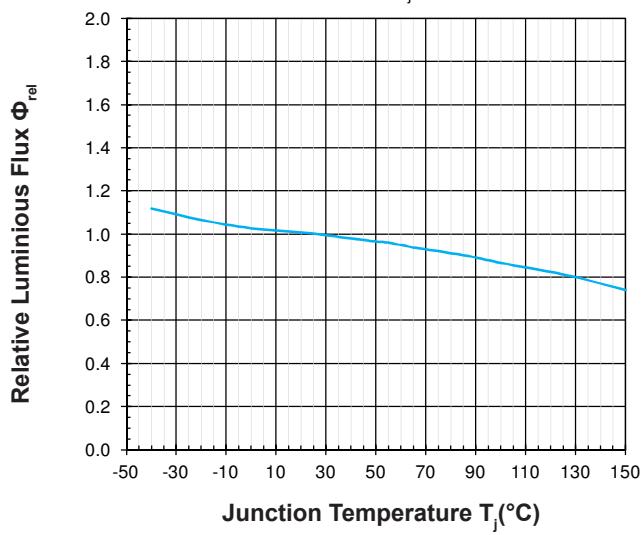
Forward Voltage Vs Junction Temperature

$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 150\text{mA}$



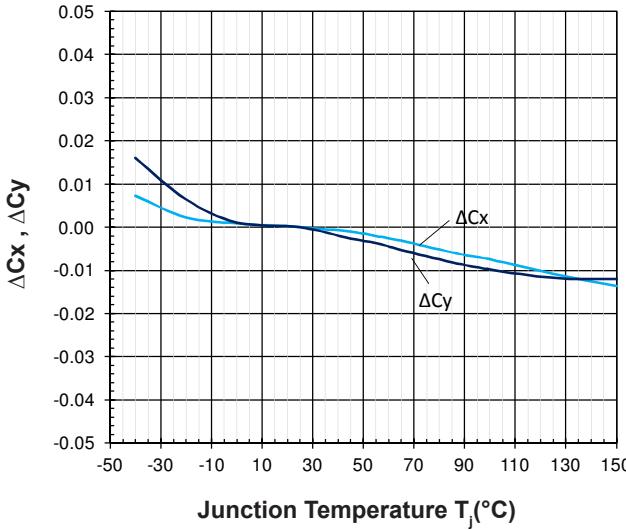
Relative Luminous Flux Vs Junction Temperature

$\Phi V/\Phi V(25^\circ\text{C}) = f(T_j); I_F = 150\text{mA}$



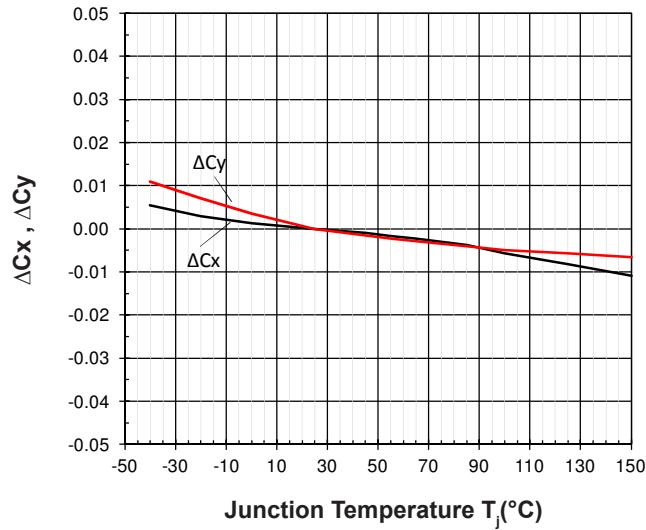
Chromaticity Coordinate Shift Vs Junction Temperature

$\Delta Cx, \Delta Cy = f(T_j); I_F = 150\text{mA}$ (Cool White)

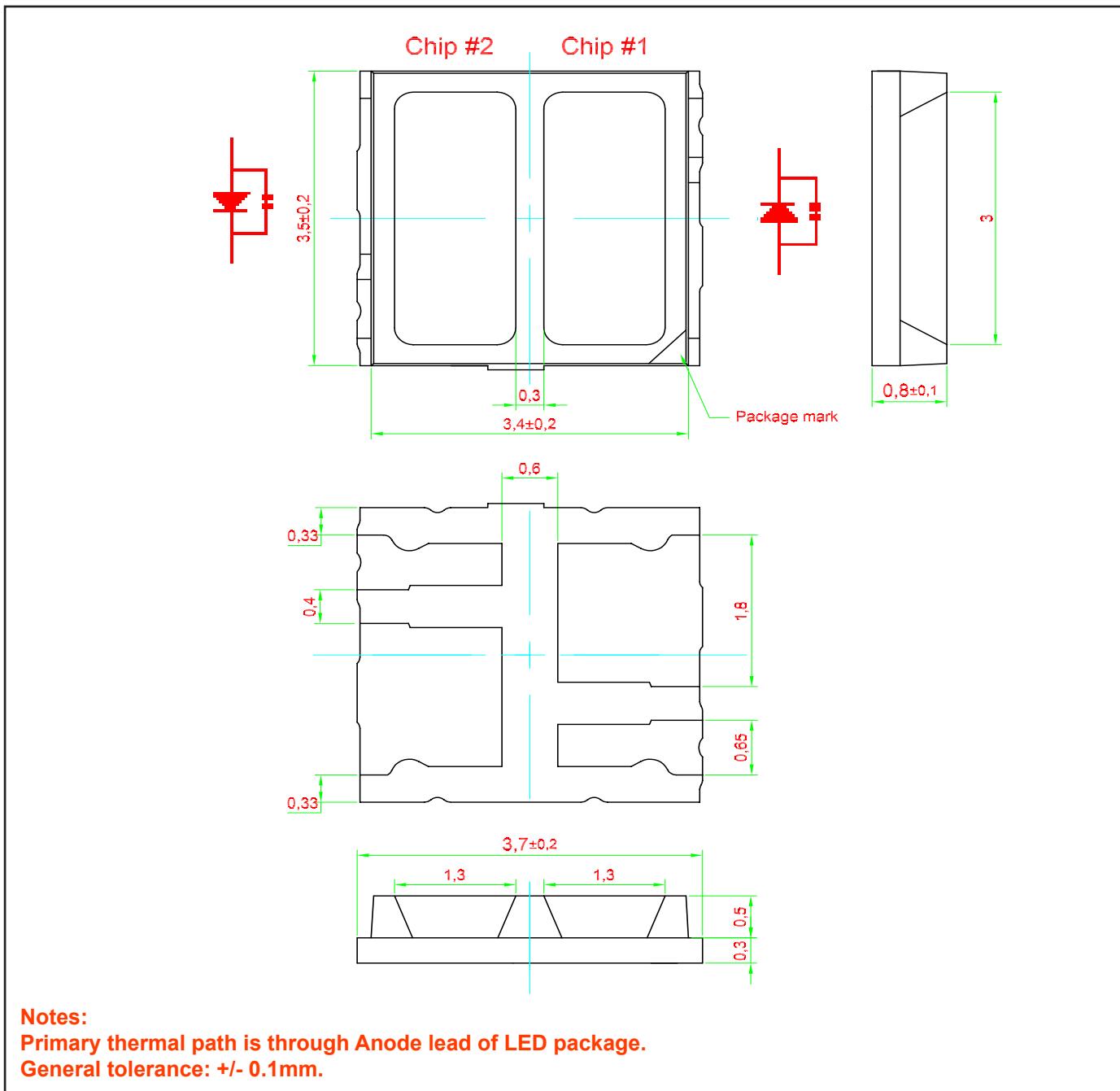


Chromaticity Coordinate Shift Vs Junction Temperature

$\Delta Cx, \Delta Cy = f(T_j); I_F = 150\text{mA}$ (Warm White)



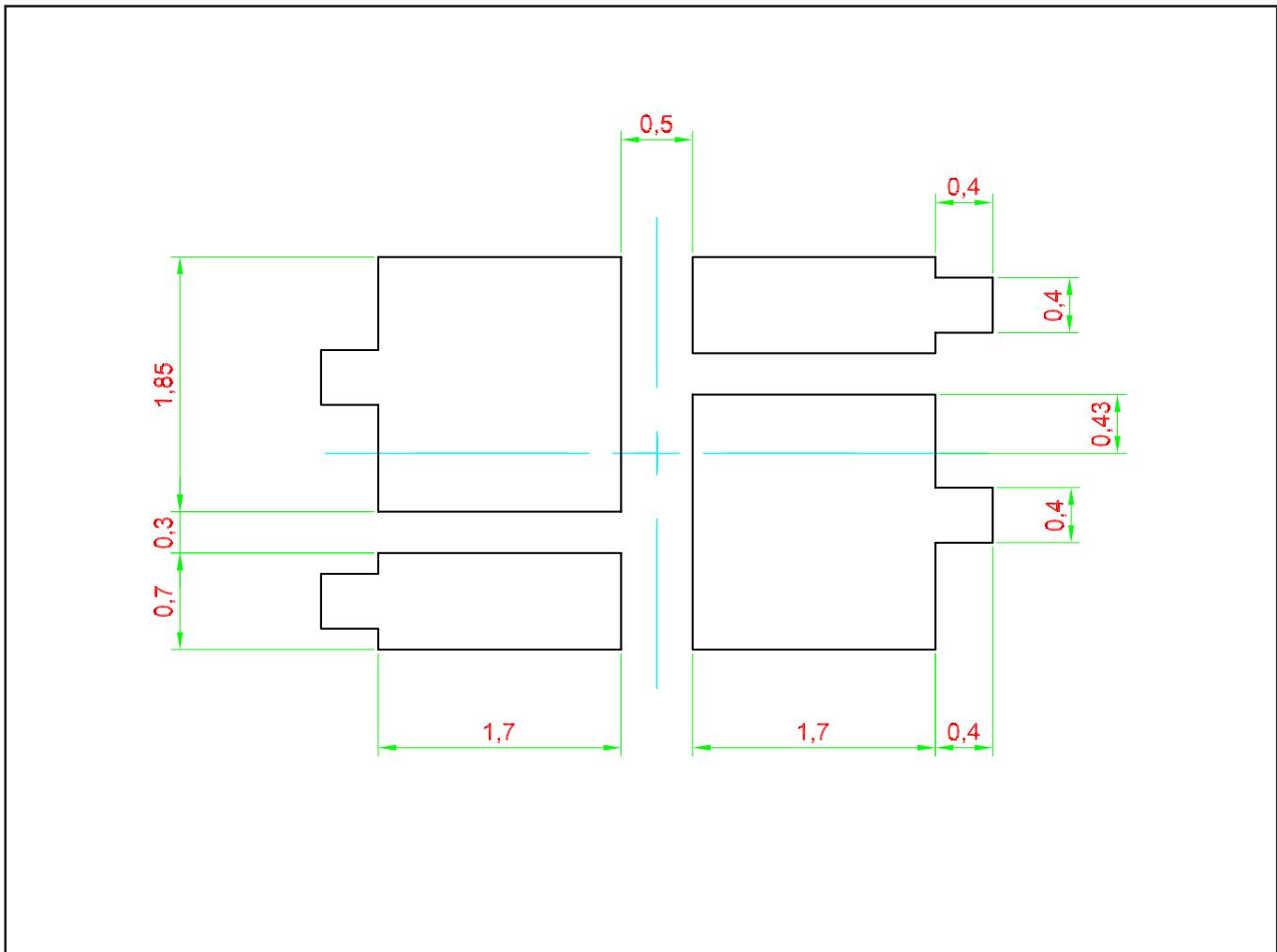
PrimaxPlus Bi-Color • InGaN: MCFW-EZHG Package Outlines



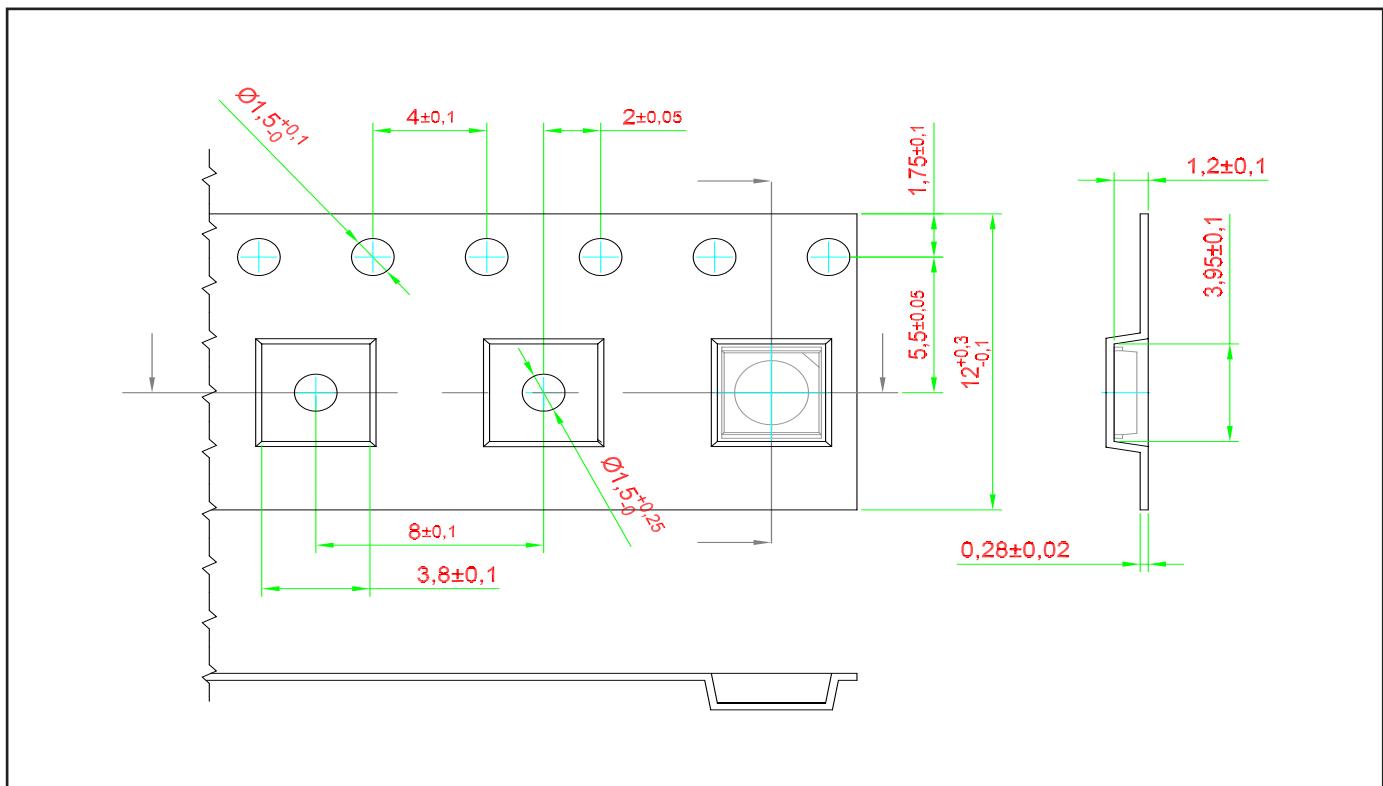
Material

Material	
Lead-frame	Cu Alloy With Au Plating
Package	High Temperature Resistant Plastic
Encapsulant	Silicone Resin
Soldering Leads	Au Plating

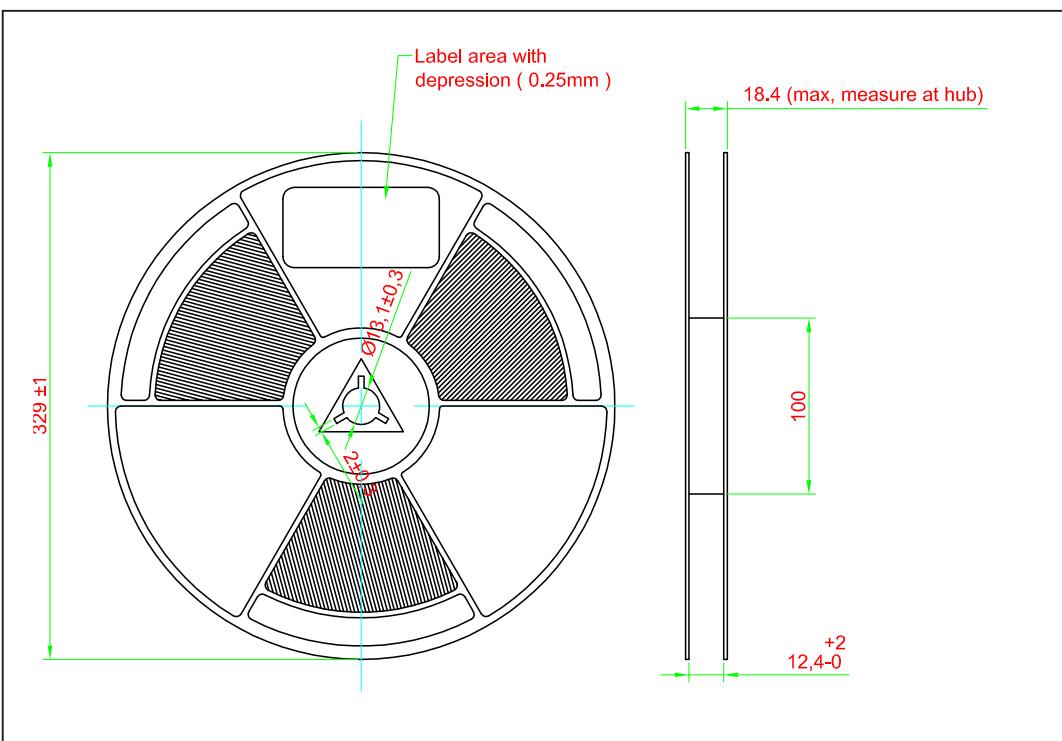
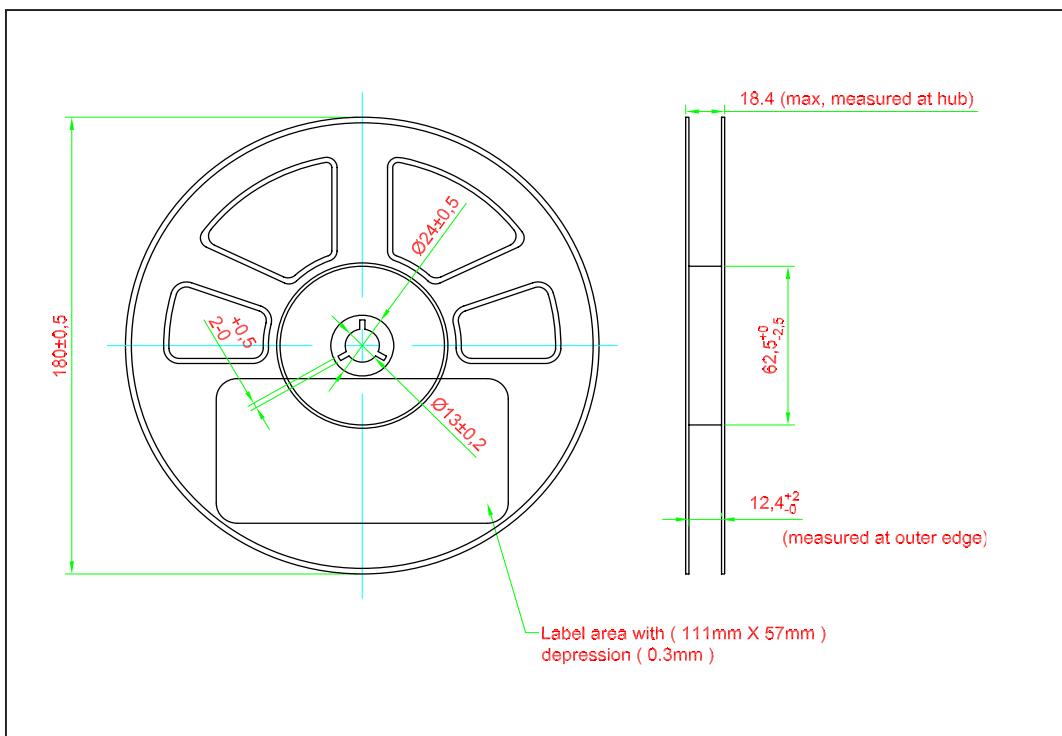
Recommended Solder Pad



Taping and orientation



Packaging Specification

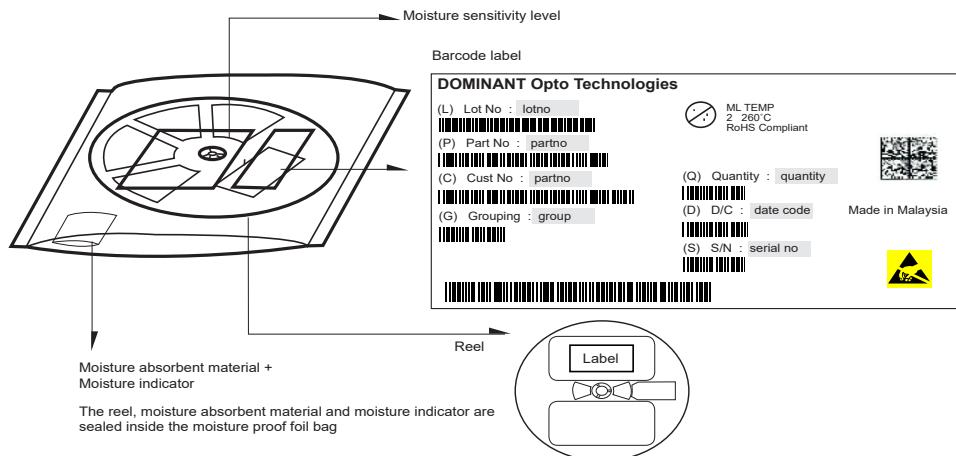


	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	1500	MCFW-EZHG-xxx+xxx-x+x
Optional Packing	329	5000	MCFW-EZHG-xxx+xxx-x+x-5

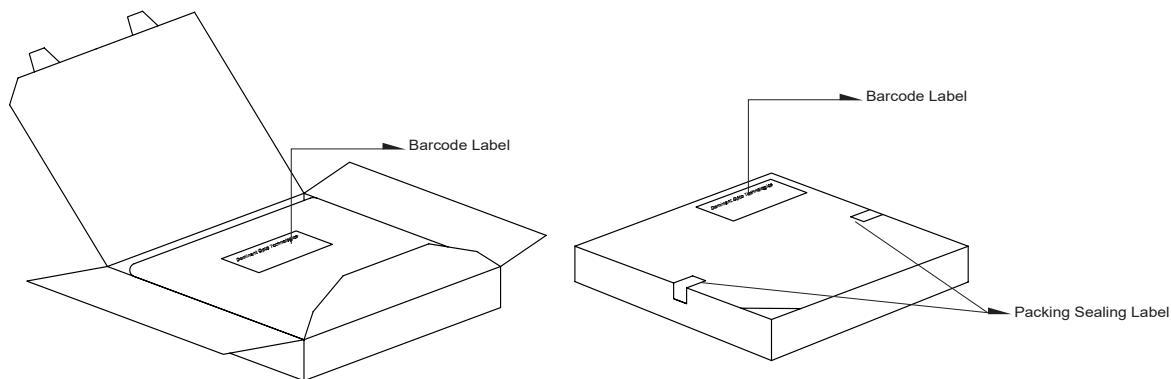
Notes:

* For ordering purpose only. Please consult sales and marketing for details.

Packaging Specification



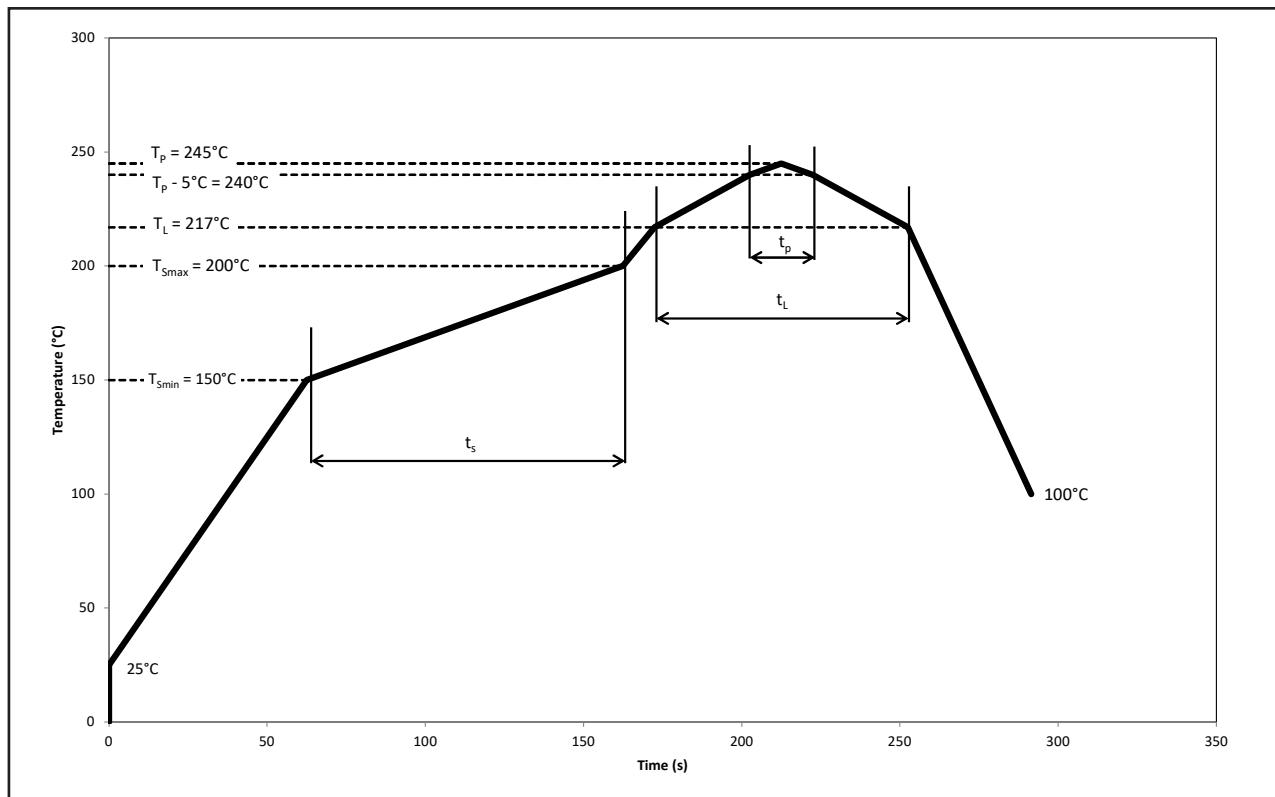
Quantity per bag (pcs)	Average 1pc PrimaxPlus (g)	1 completed bag (g)
1500	0.034	245 ± 10
5000	0.034	1150 ± 10



Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 20
329	345 x 345 x 20

Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Pb-Free Assembly					
Profile Feature	Symbol	Min.	Recommended	Max.	Unit
Ramp-up rate to preheat 25°C to T_{smin}	-	-	2	3	$^\circ\text{C}/\text{s}$
Time t_s T_{smin} to T_{smax}	t_s	60	100	120	s
Ramp-up rate to peak T_L to T_p	-	-	2	3	$^\circ\text{C}/\text{s}$
Liquidous temperature	T_L	-	217	-	$^\circ\text{C}$
Time above liquidous temperature	t_L	60	80	150	s
Peak temperature	T_p	-	245	260	$^\circ\text{C}$
Time within 5°C of the specified peak temperature $T_p - 5^\circ\text{C}$	t_p	10	20	30	s
Ramp-down rate T_p to 100°C	-	-	3	6	$^\circ\text{C}/\text{s}$
Time 25°C to T_p	-	-	-	480	s

Appendix

1) Brightness:

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of k=3).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of k=3).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of k=3).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of k=3).

2) Color:

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of k=3).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of k=3).

3) Voltage:

- 3.1 Forward Voltage, Vf is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of k=3).

4) Typical Values:

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) Tolerance of Measure

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specific in mm.

Revision History

NOTE

All the information contained in this document is considered to be reliable at the time of publishing. However, DOMINANT Opto Technologies does not assume any liability arising out of the application or use of any product described herein.

DOMINANT Opto Technologies reserves the right to make changes to any products in order to improve reliability, function or design.

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Dispose of product is in accordance with local, regional, national and international regulations.

About Us

DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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